

50 V, 200 mA NPN general-purpose transistors
Rev. 1 — 28 June 2010

Product data sheet

1. **Product profile**

1.1 General description

NPN general-purpose transistors in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

Table 1. **Product overview**

Type number	Package		PNP complement
	NXP	JEDEC	
2PD601BRL	SOT23	TO-236AB	2PB709BRL
2PD601BSL			2PB709BSL

1.2 Features and benefits

- Collector current I_C ≤ 200 mA
- Two current gain selections
- AEC-Q101 qualified
- Small SMD plastic package

1.3 Applications

General-purpose switching and amplification

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	50	V
I _C	collector current		-	-	200	mA
h _{FE}	DC current gain	$V_{CE} = 10 \text{ V};$ $I_C = 2 \text{ mA}$	210	-	460	
	h _{FE} group R		210	-	340	
	h _{FE} group S		290	-	460	



2. Pinning information

Table 3. Pinning

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Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter	3	3
3	collector	1 2	1—
			2 sym021

3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
2PD601BRL	-	plastic surface-mounted package; 3 leads	SOT23
2PD601BSL			

4. Marking

Table 5. Marking codes

Type number	Marking code ^[1]
2PD601BRL	ML*
2PD601BSL	MM*

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

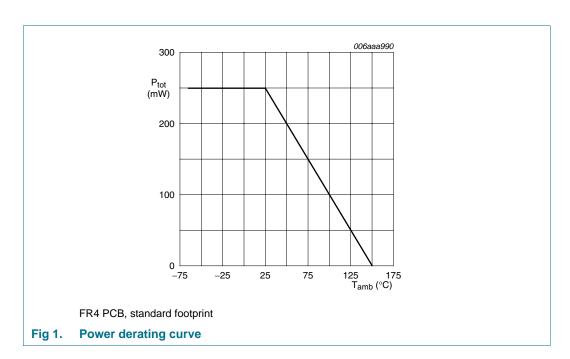
Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	60	V
V_{CEO}	collector-emitter voltage	open base	-	50	V
V_{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	200	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	300	mA
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA

 Table 6.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P_{tot}	total power dissipation	$T_{amb} \leq 25 ^{\circ}C$	<u>[1]</u> -	250	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

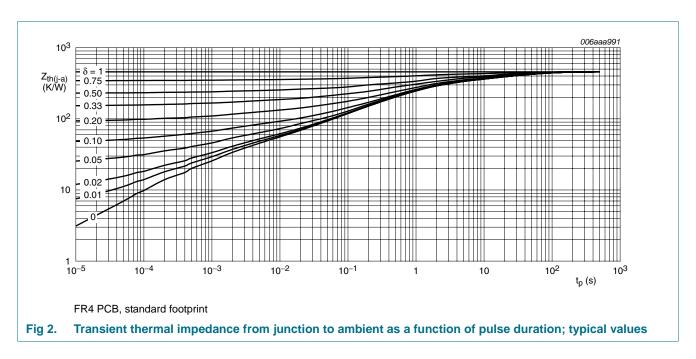


6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] -	-	500	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	140	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



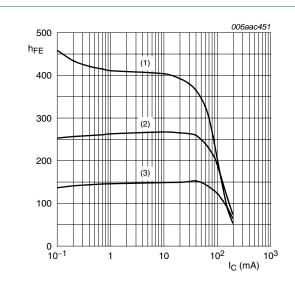
7. Characteristics

Table 8. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I_{CBO}	collector-base cut-off current	$V_{CB} = 60 \text{ V}; I_{E} = 0 \text{ A}$		-	-	10	nA
		$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$		-	-	5	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	10	nA
h _{FE}	DC current gain	$V_{CE} = 10 \text{ V};$ $I_C = 2 \text{ mA}$		210	-	460	
	h _{FE} group R			210	-	340	
	h _{FE} group S			290	-	460	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 100 \text{ mA};$ $I_B = 10 \text{ mA}$	[1]	-	-	250	mV
f _T	transition frequency	$V_{CE} = 6 \text{ V};$ $I_{C} = 10 \text{ mA};$ $f = 100 \text{ MHz}$		100	250	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V};$ $I_E = i_e = 0 \text{ A};$ $f = 1 \text{ MHz}$		-	-	3	pF

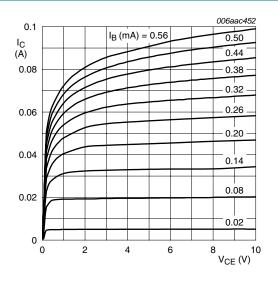
^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$



$$V_{CE} = 10 \text{ V}$$

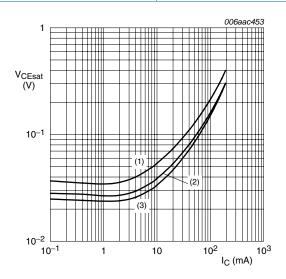
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 3. 2PD601BRL: DC current gain as a function of collector current; typical values



T_{amb} = 25 °C

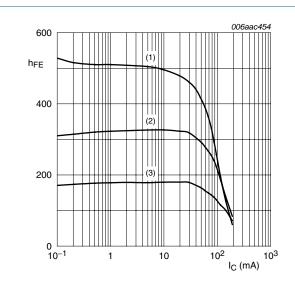
Fig 4. 2PD601BRL: Collector current as a function of collector-emitter voltage; typical values



 $I_{\rm C}/I_{\rm B} = 10$

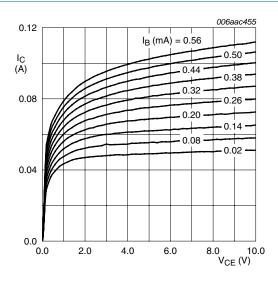
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 5. 2PD601BRL: Collector-emitter saturation voltage as a function of collector current; typical values



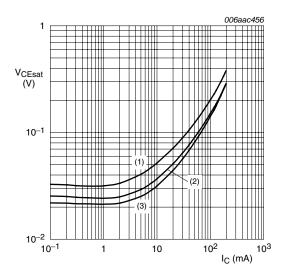
- $V_{CE} = 10 \text{ V}$
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 6. 2PD601BSL: DC current gain as a function of collector current; typical values



 $T_{amb} = 25 \, ^{\circ}C$

Fig 7. 2PD601BSL: Collector current as a function of collector-emitter voltage; typical values



- $I_{\rm C}/I_{\rm B} = 10$
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

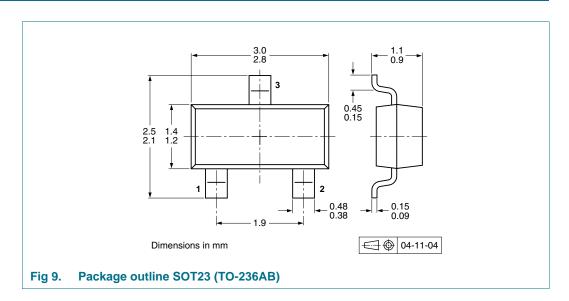
Fig 8. 2PD601BSL: Collector-emitter saturation voltage as a function of collector current; typical values

8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

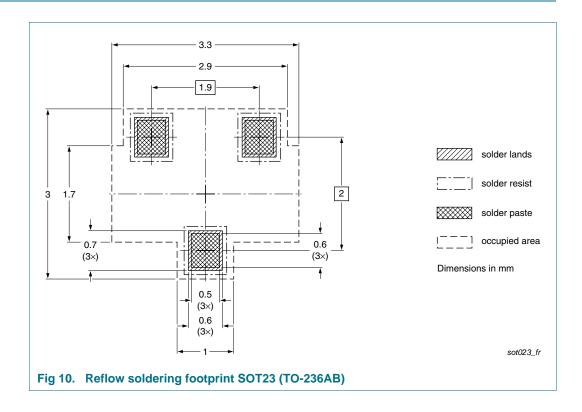
Packing methods Table 9.

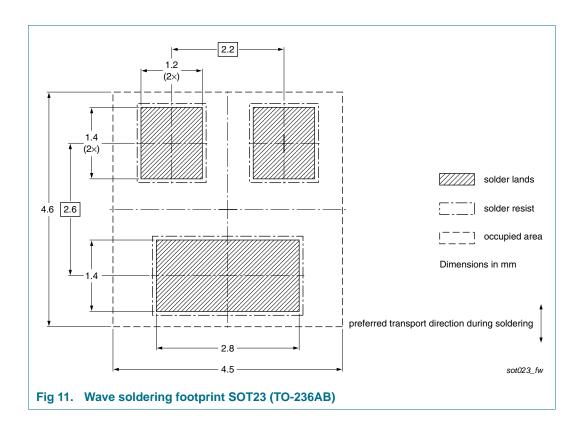
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing of	quantity
			3000	10000
2PD601BRL	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235
2PD601BSL				

^[1] For further information and the availability of packing methods, see Section 14.

11. Soldering





12. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
2PD601BRL_2PD601BSL v.1	20100628	Product data sheet	-	-

50 V, 200 mA NPN general-purpose transistors

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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